

## ANALYTICAL SERVICES

## Our fields of expertise

- Analytical techniques
  - -Failure analysis
  - -Surface analysis
  - -Material characterization
- · Reliability testing

## **Analytical services**

- · 2D & 3D X-Ray
- Fourier Transform Infrared Sectrometry (FTIR)
- Inductively Coupled Plasma Emission Spectrometry (ICP)
- · Ion milling
- · IR laser decapsulation tool
- · Acoustic microscopy
- Scanning Electron Microscopy (SEM)
- Plasma-FiB
- X-Ray Photoelectron Spectroscopy (XPS)
- · Time Domain Spectroscopy (TDR)
- Thermal Analyzers: DSC, TGA, TMA, DMA
- Thermal Desorption System-Gas Chromatograph-Mass Spectrometer (TD GC/MS)
- · Thermal Topography (TherMoiré)
- · Vector Network Analyzer (VNA)





## **Reliability Testing**

The product reliability can be evaluated by accelerated aging tests. According to the specifications for the product, several tests can be performed:

- DTC/ATC (thermal cycling)
- HAST (Highly Accelerated Stress Test)
- THB (Temperature, humidity, bias voltage)
- HTS (High Temperature Storage)
- EM (Electromigration)
- Vibration
- Impact shock



MiQro Innovation Collaborative Centre

45 boulevard de l'Aéroport Bromont, QC, Canada, J2L 1S8 450-534-8000 www.c2mi.ca

